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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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## 2SK3069

# Silicon N Channel MOS FET High Speed Power Switching

REJ03G1062-1100

(Previous: ADE-208-694I)

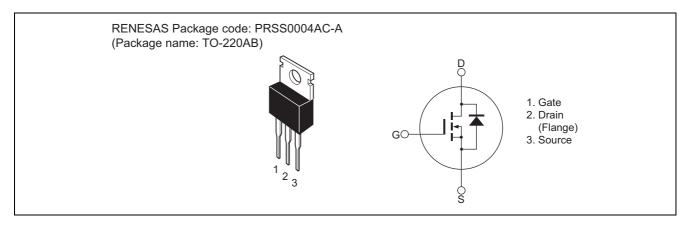
Rev.11.00

Sep 07, 2005

#### **Features**

- Low on-resistance  $R_{DS(on)} = 6 \text{ m}\Omega \text{ typ.}$
- Low drive current
- 4 V gate drive device can be driven from 5 V source

## **Outline**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	60	V	
Gate to source voltage	V <sub>GSS</sub>	±20	V	
Drain current	I <sub>D</sub>	75	А	
Drain peak current	I <sub>D(pulse)</sub> Note 1	300	А	
Body-drain diode reverse drain current	I <sub>DR</sub>	75	Α	
Avalanche current	I <sub>AP</sub> Note 3	50	А	
Avalanche energy	E <sub>AR</sub> Note 3	214	mJ	
Channel dissipation	Pch Note 2	100	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW  $\leq$  10 $\mu$ s, duty cycle  $\leq$  1 %

2. Value at Tc = 25°C

3. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

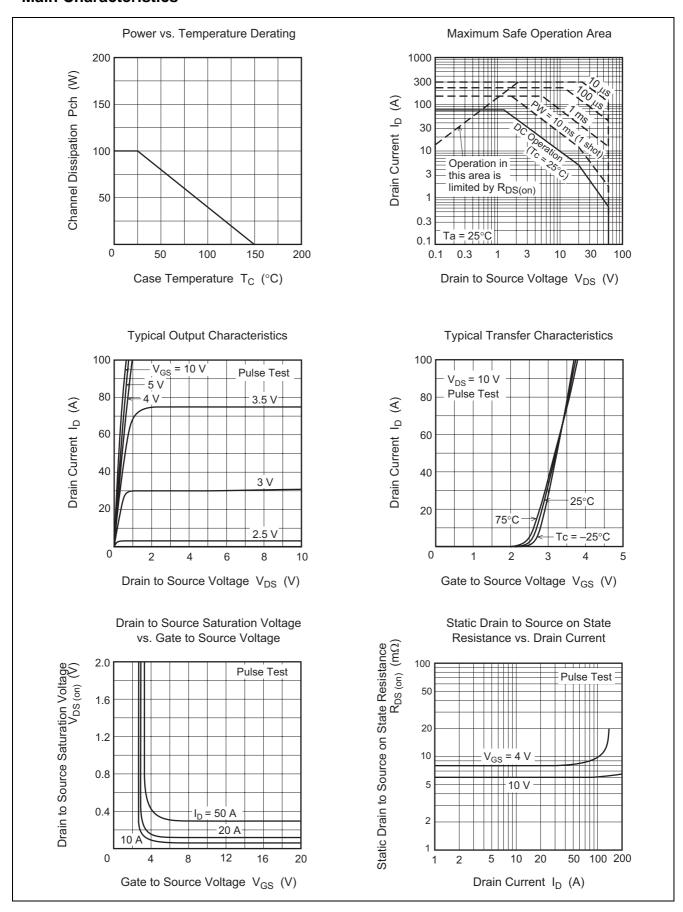
## **Electrical Characteristics**

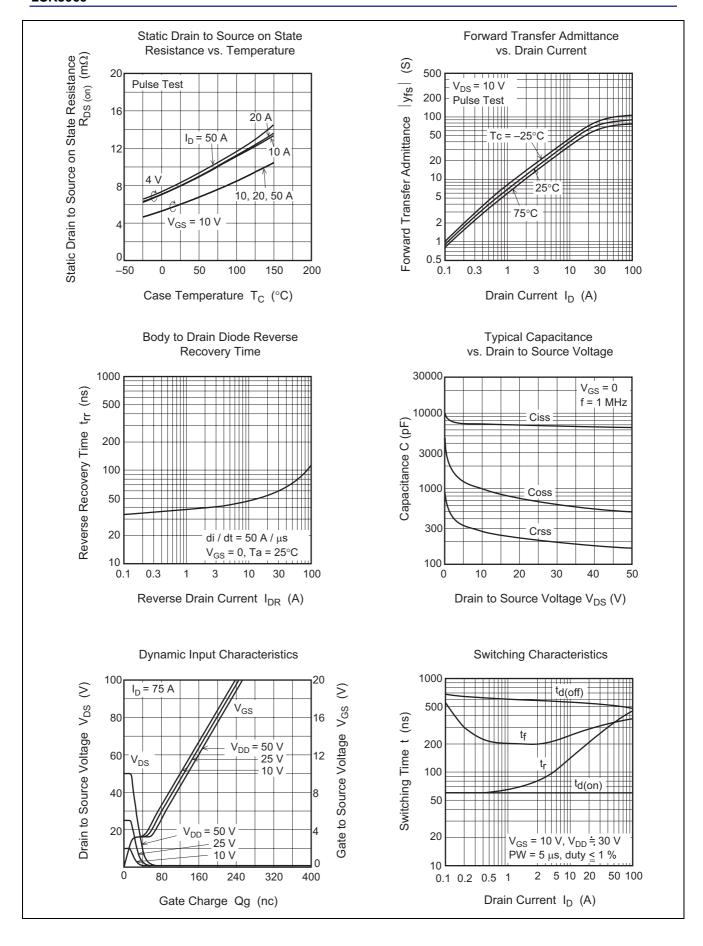
 $(Ta = 25^{\circ}C)$ 

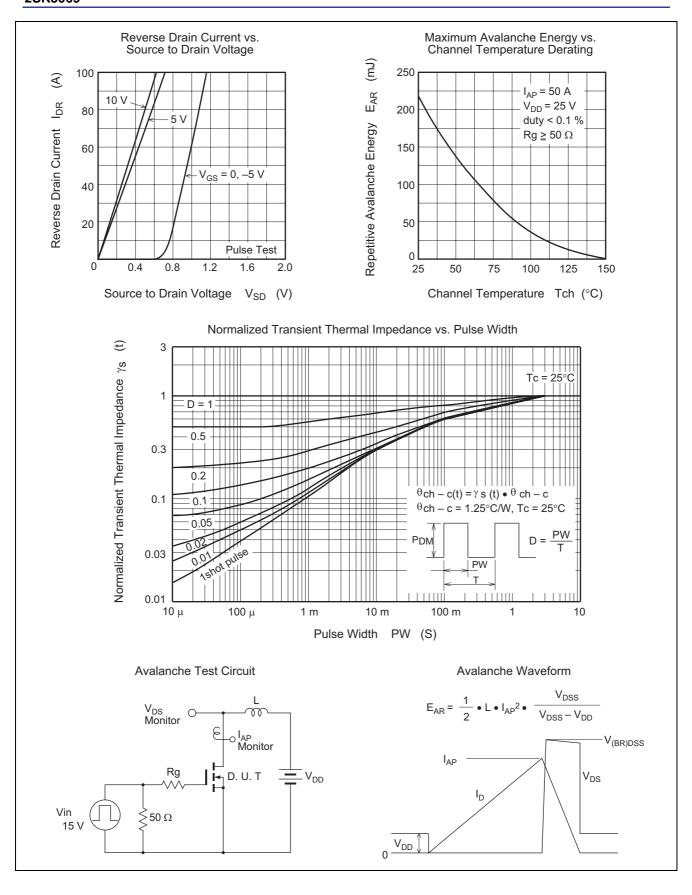
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	10	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.5	V	$I_D = 1$ mA, $V_{DS} = 10$ V Note 4
Static drain to source on state	R <sub>DS(on)</sub>	_	6.0	7.5	mΩ	$I_D = 40 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 4}}$
resistance		_	8.0	12	mΩ	$I_D = 40 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note 4}}$
Forward transfer admittance	y <sub>fs</sub>	50	80	_	S	$I_D = 40 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 4}}$
Input capacitance	Ciss	_	7100	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	1000	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	280	_	pF	
Total gate charge	Qg	_	125	_	nC	$V_{DD} = 25 \text{ V}, V_{GS} = 10 \text{ V},$
Gate to source charge	Qgs	_	25	_	nC	I <sub>D</sub> = 75 A
Gate to drain charge	Qgd	_	25	_	nC	
Turn-on delay time	t <sub>d(on)</sub>	_	60	_	ns	$V_{GS} = 10 \text{ V}, I_D = 40 \text{ A},$
Rise time	t <sub>r</sub>	_	300	_	ns	$R_L = 0.75 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	520	_	ns	
Fall time	t <sub>f</sub>	_	330	_	ns	]
Body-drain diode forward voltage	$V_{DF}$	_	1.05	_	V	$I_F = 75A, V_{GS} = 0$
Body-drain diode reverse recovery time	t <sub>rr</sub>	_	90	_	ns	$I_F = 75A$ , $V_{GS} = 0$ $di_F/dt = 50 A/ \mu s$

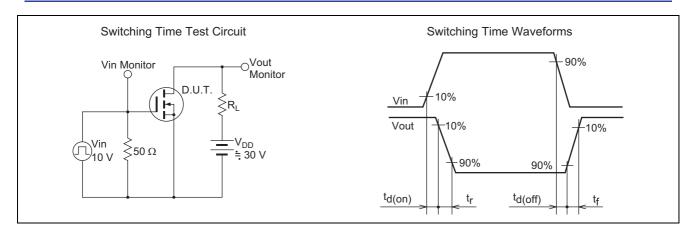
Note: 4. Pulse test

#### **Main Characteristics**

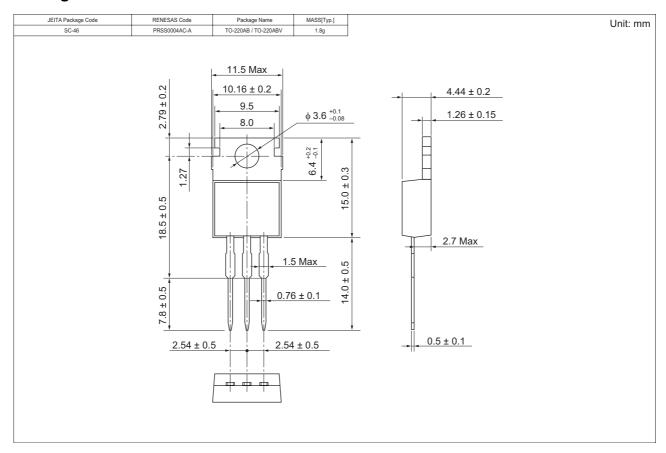








## **Package Dimensions**



## **Ordering Information**

Part Name	Quantity	Shipping Container
2SK3069-E	500 pcs	Box (Sack)

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